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Part Number: [1718140002](#)
Status: **Active**
Overview: [KK® Interconnect System - Molex](#)
Description: 3.96mm Pitch, KK 396 RPC Wire-to-Board Right-Angle Header with Friction Lock, Tin (Sn) Plating, Bag, 2 Circuits

Documents:

3D Model	3D Model (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	PCB Headers
Series	171814
Application	Power, Signal, Wire-to-Board
Overview	KK® Interconnect System - Molex
Product Name	KK 396
UPC	887191375649

Physical

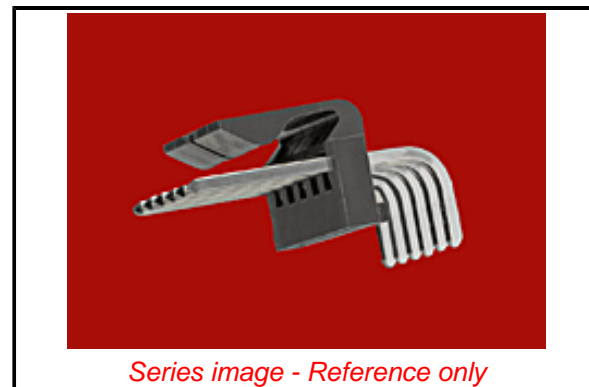
Breakaway	No
Circuits (Loaded)	2
Circuits (maximum)	2
Color - Resin	Black
Durability (mating cycles max)	25
First Mate / Last Break	No
Flammability	94V-1
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Plating Mating	Tin
Material - Plating Termination	Nickel
Material - Resin	Nylon
Net Weight	0.780/g
Number of Rows	1
Orientation	Right Angle
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Bag
Pitch - Mating Interface	3.96mm
Shrouded	Partial
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40° to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	7.0A
Voltage - Maximum	250V

Solder Process Data

Duration at Max. Process Temperature (seconds)	030
Lead-freeProcess Capability	SMC&WAVE



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

REACH SVHC

Not Contained Per -
D(2020)4578-DC (25
June 2020)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

ELV

RoHS Phthalates

China RoHS

Green Image

Not Relevant

Not Contained

Search Parts in this Series

[171814 Series](#)

Max. Cycles at Max. Process Temperature	003
Process Temperature max. C	260

Material Info

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